Triple Inverters

HITACHI

ADE-205-664 (Z)

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Description

The HD74LV2GT04A has triple inverters in a 8 pin package. Low voltage and high speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

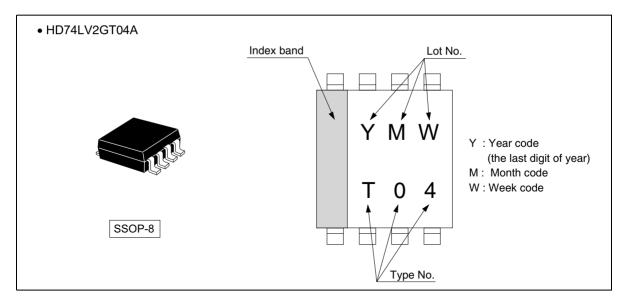
Features

- The basic gate function is lined up as hitachi uni logic series.
- Supplied on emboss taping for high speed automatic mounting.
- TTL compatible input level.
 - Supply voltage range: 4.5 to 5.5 V
 - Operating temperature range: -40 to +85°C
- All inputs V_{H} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V) All outputs V_{O} (Max.) = 5.5 V (@ V_{CC} = 0 V)
- Output current $\pm 12 \text{ mA}$ (@V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Package type

Package type	Package code	Package suffix	Taping code
SSOP-8 pin	TTP-8DB	US	E (3,000 pcs / Reel)



Outline and Article Indication

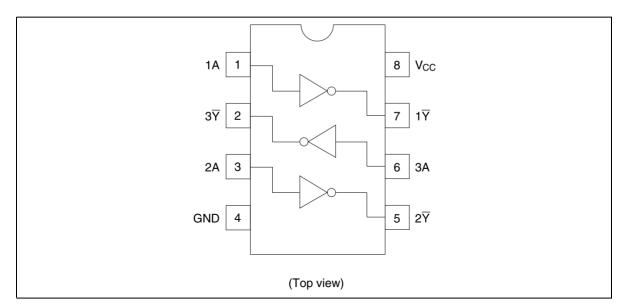


Function Table

Input A	Output \overline{Y}
Н	L
L	Н

H : High level L : Low level

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions	
Supply voltage range	V _{cc}	-0.5 to 7.0	V		
Input voltage range *1	V _I	-0.5 to 7.0	V		
Output voltage range *1, 2	V _o	-0.5 to $V_{cc} + 0.5$	V	Output : H or L	
		-0.5 to 7.0		V _{cc} : OFF	
Input clamp current	I _{IK}	-20	mA	V ₁ < 0	
Output clamp current	I _{ok}	±50	mA	$V_{o} < 0 \text{ or } V_{o} > V_{cc}$	
Continuous output current	Io	±25	mA	$V_{o} = 0 \text{ to } V_{cc}$	
Continuous current through V_{cc} or GND	I _{CC} or I _{GND}	±50	mA		
Maximum power dissipation at Ta = 25°C (in still air) ³	P _T	200	mW		
Storage temperature	Tstg	-65 to 150	°C		

Notes:

- The absolute maximum ratings are values which must not individually be exceeded, and furthermore no two of which may be realized at the same time.
- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{cc}	4.5	5.5	V	
Input voltage range	V _i	0	5.5	V	
Output voltage range	V _o	0	V _{cc}	V	
Output current	I _{OH}	_	12	mA	$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
	I _{OL}	_	-12		$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt / Δν	0	20	ns / V	$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	T _a	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristic

• $Ta = -40 \text{ to } 85^{\circ}\text{C}$

Item	Symbol	V _{cc} (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V _{IH}	4.5 to 5.5	2.0	_	_	V	
	V _{IL}	4.5 to 5.5	_	_	0.8	_	
Hysteresis voltage	V _H	5.0	_	0.15	_	V	$V_T^+ - V_T^-$
Output voltage	V _{OH}	Min to Max	V _{cc} -0.1	_	_	V	$I_{OH} = -50 \mu A$
		4.5	3.8	_	_	_	I _{OH} = -12 mA
	V _{oL}	Min to Max	_	_	0.1	_	$I_{OL} = 50 \mu A$
		4.5	_	_	0.55	_	I _{oL} = 12 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Quiescent supply current	I _{cc}	5.5	_	_	10	μА	$V_{IN} = V_{CC}$ or GND, $I_{O} = 0$
	ΔI_{cc}	5.5	_		1.5	mA	One input $V_{IN} = 3.4 \text{ V}$, other input V_{CC} or GND
Output leakage current	I _{OFF}	0	_	_	5	μΑ	V_i or $V_o = 0$ to 5.5 V
Input capacitance	C _{IN}	5.0	_	3.0	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

• $V_{cc} = 5.0 \pm 0.5 \text{ V}$

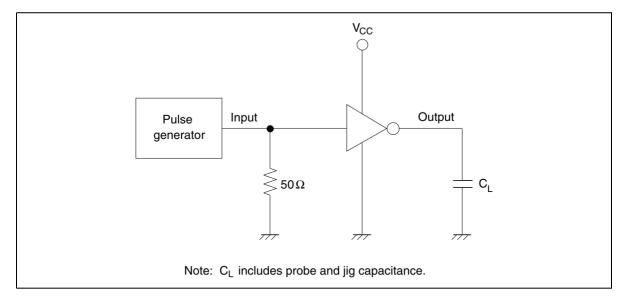
Item	Symbol	Ta = 2	25°C		Ta = -40 to 85°C		Unit		FROM	TO
		Min	Тур	Max	Min	Max	_	Conditions ((Input)	(Output)
Propagation	t _{PLH}	_	5.0	7.0	1.0	8.0	ns	$C_L = 15 pF$	A	Y
delay time	t _{PHL}	_	8.0	10.5	1.0	12.0	_	C _L = 50 pF		

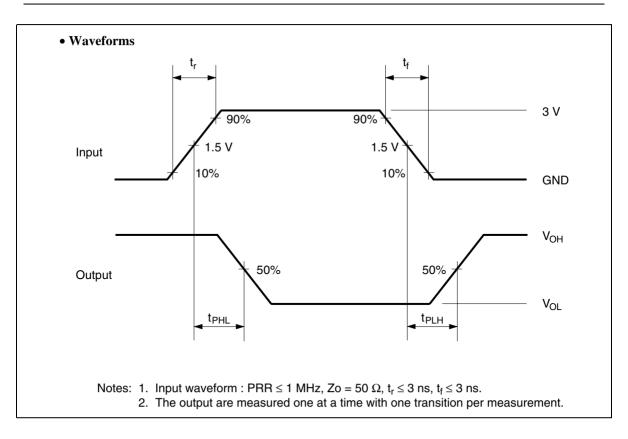
Operating Characteristics

• $C_1 = 50 \text{ pF}$

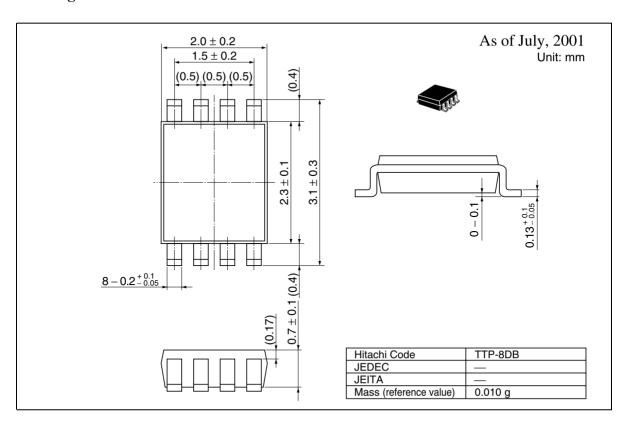
Item	Symbol	$V_{cc}(V)$	Ta = 2	Ta = 25°C			Test Conditions
			Min	Тур	Max		
Power dissipation capacitance	$C_{\scriptscriptstyle{PD}}$	5.0	_	10.0	_	pF	f = 10 MHz

Test Circuit





Package Dimensions



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